

IRK.F112.. SERIES

**FAST THYRISTOR/ DIODE and
 THYRISTOR/ THYRISTOR**

INT-A-pak™ Power Modules

112 A

Features

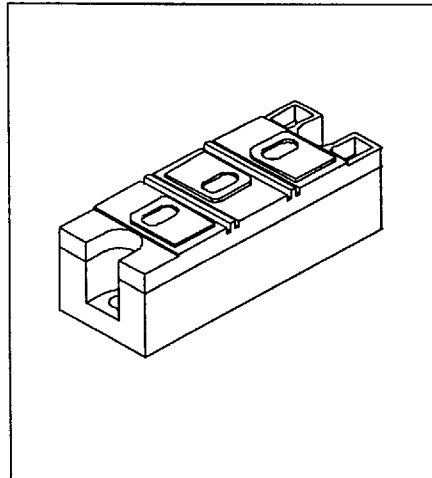
- Fast turn-off thyristor
- Fast recovery diode
- High surge capability
- Electrically isolated baseplate
- 3000 V_{RMS} isolating voltage
- Industrial standard package
- UL E78996 approved 

Description

These series of INT-A-pak modules are intended for applications such as self-commutated inverters, DC choppers, electronic welders, induction heating and others where fast switching characteristics are required.

Major Ratings and Characteristics

Parameters	IRK.F112..	Units
$I_{T(AV)}$	112	A
@ T_c	90	°C
$I_{T(RMS)}$	250	A
I_{TSM}	@ 50Hz	3090
	@ 60Hz	3237
i^2t	@ 50Hz	47.8
	@ 60Hz	43.6
i^2-t	478	KA ² /s
t_q	10 and 15	µs
t_{rr}	2	µs
V_{DRM}/V_{RRM}	up to 800	V
T_J range	-40 to 125	°C



IRK.F112.. Series

Bulletin I27081 rev. A 09/97

International
IR Rectifier

ELECTRICAL SPECIFICATIONS

Voltage Ratings

Type number	Voltage Code	V_{RRM}/V_{DRM} maximum repetitive peak reverse voltage V	V_{RSM} maximum non-repetitive peak rev. voltage V	I_{RRM}/I_{DRM} max. @ $T_J = 125^\circ\text{C}$ mA
IRK.F112.. Series	04	400	400	30
	08	800	800	

Current Carrying Capacity

Frequency f							Units
	Value 1	Value 2	Value 1	Value 2	Value 1	Value 2	
50Hz	220	220	350	550	2060	2900	A
400Hz	285	285	425	695	1230	1785	A
2500Hz	205	205	350	550	460	552	A
5000Hz	175	170	295	448	295	448	A
10000Hz	125	120	230	337	-	-	A
Recovery voltage Vr	50	50	50	50	50	50	V
Voltage before turn-on Vd	80% V_{DRM}		80% V_{DRM}		80% V_{DRM}		V
Rise of on-state current di/dt	50	50	-	-	-	-	A/µs
Case temperature	90	60	90	60	90	60	°C
Equivalent values for RC circuit	47 Ω / 0.22 µF		47 Ω / 0.22 µF		47 Ω / 0.22 µF		

On-state Conduction

Parameter	IRK.F112..	Units	Conditions
$I_{T(AV)}$ Maximum average on-state current @ Case temperature	112	A	180° conduction, half sine wave
	90	°C	
$I_{T(RMS)}$ Maximum RMS current	250	A	$T_C = 90^\circ\text{C}$, as AC switch
I_{TSM} Maximum peak, one-cycle, non-repetitive surge current	3090	A	t = 10ms No voltage
	3237		t = 8.3ms reapplied
	2600		t = 10ms 100% V_{RRM}
	2720		t = 8.3ms reapplied
F^t Maximum F^t for fusing	47.8	KA ² s	t = 10ms No voltage
	43.6		t = 8.3ms reapplied
	33.8		t = 10ms 100% V_{RRM}
	30.8		t = 8.3ms reapplied
F^t Maximum F^t for fusing	478	KA ² √s	t = 0 to 10ms, no voltage reapplied
$V_{T(TH)1}$ Low level value of threshold voltage	1.19	V	(16.7% x π x $I_{T(AV)} < I < \pi$ x $I_{T(AV)}$), $T_J = T_J$ max.
$V_{T(TH)2}$ High level value of threshold voltage	1.43		($I > \pi$ x $I_{T(AV)}$), $T_J = T_J$ max.
r_{11} Low level value of on-state slope resistance	1.67	mW	(16.7% x π x $I_{T(AV)} < I < \pi$ x $I_{T(AV)}$), $T_J = T_J$ max.
r_{12} High level value of on-state slope resistance	1.12		($I > \pi$ x $I_{T(AV)}$), $T_J = T_J$ max.
V_{TM} Maximum on-state voltage drop	1.77	V	$I_{pk} = 350\text{A}$, $T_J = T_J$ max., $t_p = 10\text{ms}$ sine pulse
I_H Maximum holding current	600	mA	$T_J = 25^\circ\text{C}$, $I_p > 30\text{A}$
I_L Typical latching current	1000	mA	$T_J = 25^\circ\text{C}$, $V_A = 12\text{V}$, $R_a = 6\Omega$, $I_g = 1\text{A}$

Switching

Parameter	IRK.F112..	Units	Conditions
di/dt Maximum non-repetitive rate of rise	800	A/ μ s	Gate drive 20V, 20 Ω , $t_r \leq 1$ ms, $V_D = 80\% V_{DRM}$ $T_J = 125^\circ\text{C}$
t_{rr} Maximum recovery time	2	μ s	$I_{TM} = 350$ A, $di/dt = -25$ A/ μ s, $V_R = 50$ V, $T_J = 25^\circ\text{C}$
t_q Maximum turn-off time	N	L	$I_{TM} = 350$ A, $T_J = 125^\circ\text{C}$, $di/dt = -25$ A/ μ s, $V_R = 50$ V, $dv/dt = 400$ V/ μ s linear to $80\% V_{DRM}$
	10	15	

Blocking

Parameter	IRK.F112..	Units	Conditions
dv/dt Maximum critical rate of rise of off-state voltage	1000	V/ μ s	$T_J = 125^\circ\text{C}$., exponential to $67\% V_{DRM}$
V_{INS} RMS isolation voltage	3000	V	50 Hz, circuit to base, $T_J = 25^\circ\text{C}$, $t = 1$ s
I_{RRM} Maximum peak reverse and off-state leakage current I_{DRM}	30	mA	$T_J = 125^\circ\text{C}$, rated V_{DRM}/V_{RRM} applied

Triggering

Parameter	IRK.F112..	Units	Conditions
P_{GM} Maximum peak gate power	60	W	$f = 50$ Hz, $d\% = 50$
$P_{G(AV)}$ Maximum peak average gate power	10	W	$T_J = 125^\circ\text{C}$, $f = 50$ Hz, $d\% = 50$
I_{GM} Maximum peak positive gate current	10	A	$T_J = 125^\circ\text{C}$, $t_p \leq 5$ ms
$-V_{GM}$ Maximum peak negative gate voltage	5	V	
I_{GT} Max. DC gate current required to trigger	200	mA	$T_J = 25^\circ\text{C}$, $V_{ak} = 12$ V, $R_a = 6$
V_{GT} DC gate voltage required to trigger	3	V	
I_{GD} DC gate current not to trigger	20	mA	$T_J = 125^\circ\text{C}$, rated V_{DRM} applied
V_{GD} DC gate voltage not to trigger	0.25	V	

Thermal and Mechanical Specifications

Parameter	IRK.F112..	Units	Conditions
T_J Max. junction operating temperature range	- 40 to 125	$^\circ\text{C}$	
T_{stg} Max. storage temperature range	- 40 to 150		
R_{thJC} Max. thermal resistance, junction to case	0.17	K/W	Per junction, DC operation
R_{thChs} Max. thermal resistance, case to heatsink	0.035	K/W	Mounting surface flat and greased Per module
T Mounting torque $\pm 10\%$	IAP to heatsink	4 - 6 (35 - 53)	Nm (lb*in)
	busbar to IAP	4 - 6 (35 - 53)	
wt Approximate weight	500 (17.8)	g (oz)	A mounting compound is recommended. The torque should be rechecked after a period of 3 hours to allow for the spread of the compound. Use of cable lugs is not recommended, busbars should be used and restrained during tightening. Threads must be lubricated with a compound

IRK.F112.. Series

Bulletin I27091 rev. A 09/97

International
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ΔR_{thJC} Conduction

(The following table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction	Rectangular conduction	Units	Conditions
180°	0.015	0.012	K/W	$T_J = 125^\circ\text{C}$
120°	0.018	0.020		
90°	0.024	0.027		
60°	0.036	0.037		
30°	0.060	0.060		

Ordering Information Table

Device Code

IRK	T	F	11	2	-	08	H	L	N
①	②	③	④	⑤		⑥	⑦	⑧	⑨

- 1** - Module type
- 2** - Circuit configuration
- 3** - Fast SCR
- 4** - Current rating: $I_{T(AV)} \times 10$ rounded
- 5** - 1 = option with spacers and longer terminal screws
2 = option with standard terminal screws
- 6** - Voltage code: Code $\times 100 = V_{RRM}$ (See Voltage Ratings Table)
- 7** - dv/dt code: $H \leq 400V/\mu s$
- 8** - t_q code: $N \leq 10\mu s$
 $L \leq 15\mu s$
- 9** - None = Standard devices
N = Aluminum nitride substrate

NOTE: To order the Optional Hardware see Bulletin I27900

Outline Table

(SEE TABLE) A A

94(3.70)

80(3.15)

3 Screws M6 x 1

2 HOLES \varnothing 6.5

34 (1.34)

7 (0.27)

8 (0.32)

- All dimensions in millimeters (inches)
- Dimensions are nominal
- Full engineering drawings are available on request
- UL identification number for gate and cathode wire: UL 1385
- UL identification number for package: UL 94V0

For all types	A	B	C	D	E
IRK...1	25 (0.98)	---	---	41 (1.61)	47 (1.85)
IRK...2	23 (0.91)	30 (1.18)	36 (1.42)	---	---

IRKTF.. IRKHF.. IRKLF.. IRKUF.. IRKVF.. IRKKF.. IRKNF..

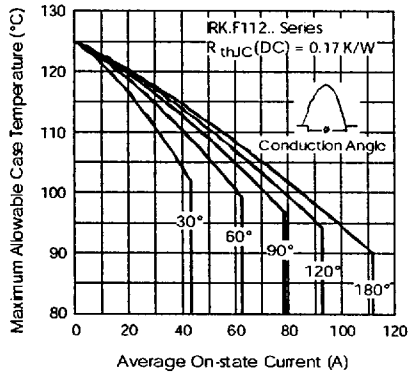


Fig. 1 - Current Ratings Characteristics

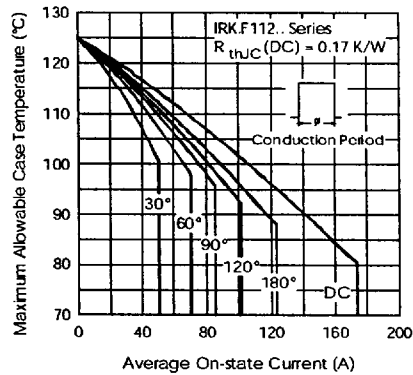


Fig. 2 - Current Ratings Characteristics

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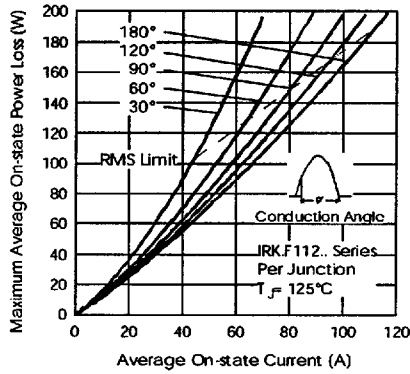


Fig. 3 - On-state Power Loss Characteristics

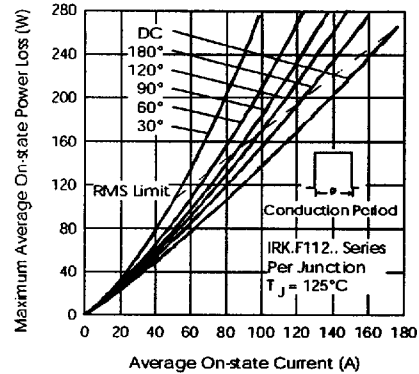


Fig. 4 - On-state Power Loss Characteristics

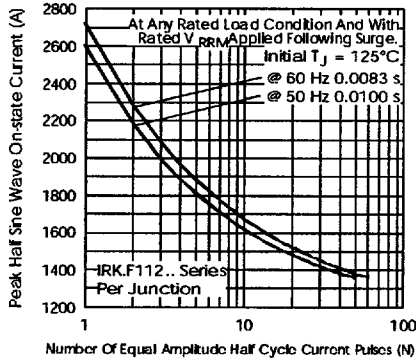


Fig. 5 - Maximum Non-Repetitive Surge Current

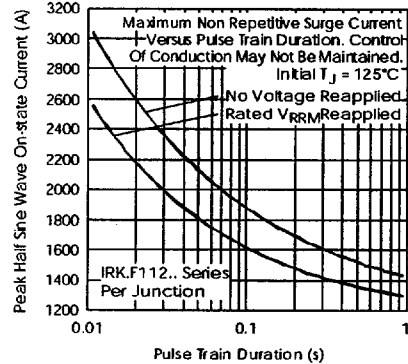


Fig. 6 - Maximum Non-Repetitive Surge Current

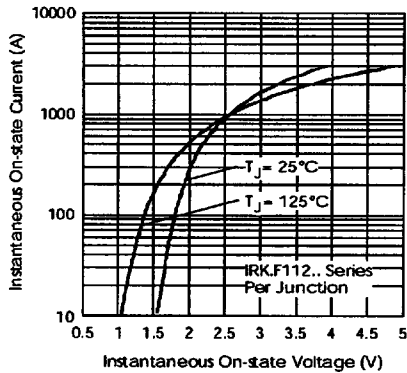


Fig. 7 - On-state Voltage Drop Characteristics

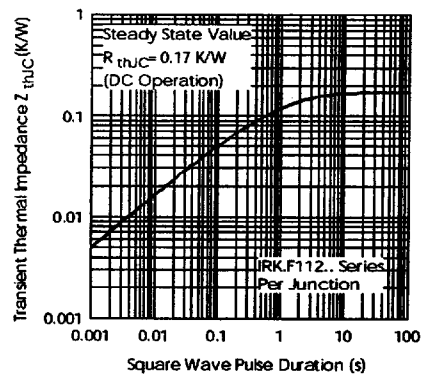


Fig. 8 - Thermal Impedance Z_{thJC} Characteristic

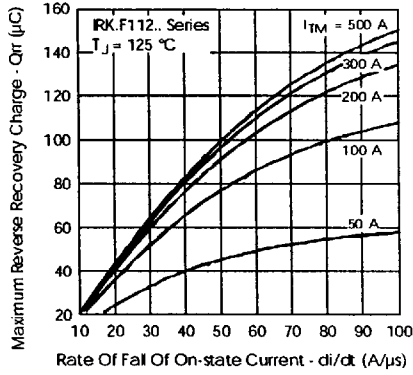


Fig. 9 - Reverse Recovery Charge Characteristics

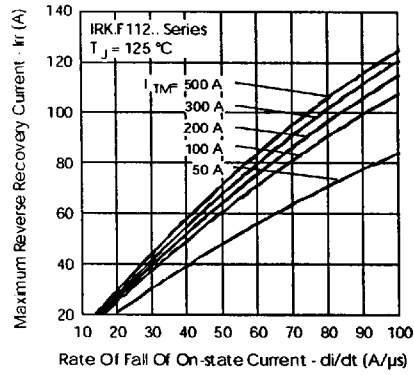


Fig. 10 - Reverse Recovery Current Characteristics

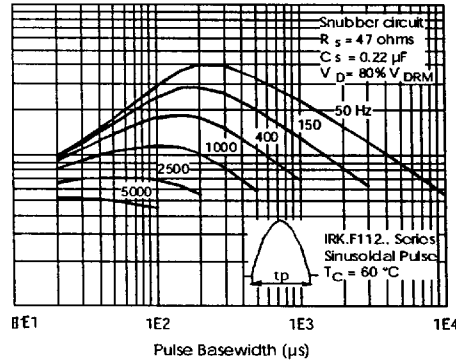
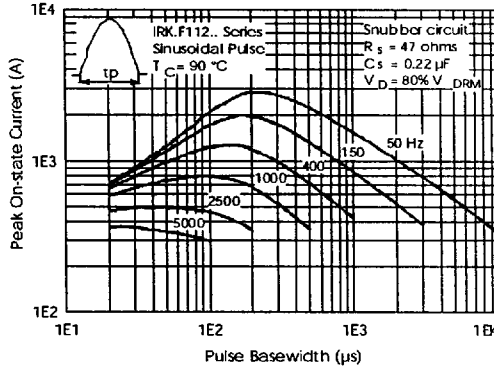


Fig. 11 - Frequency Characteristics

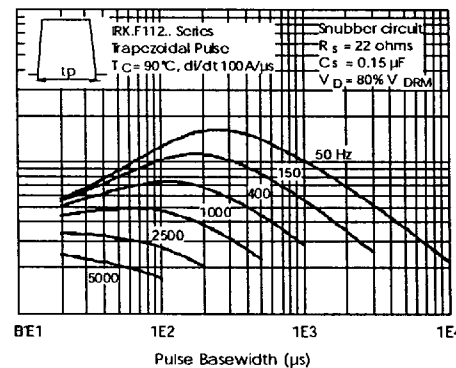
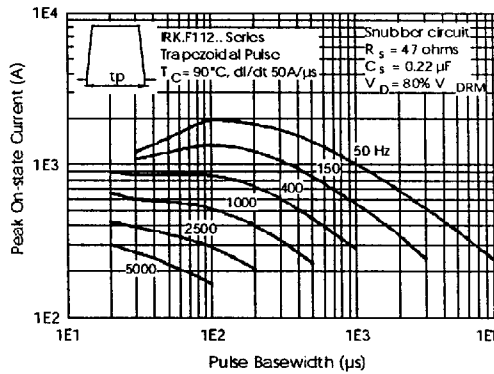


Fig. 12 - Frequency Characteristics

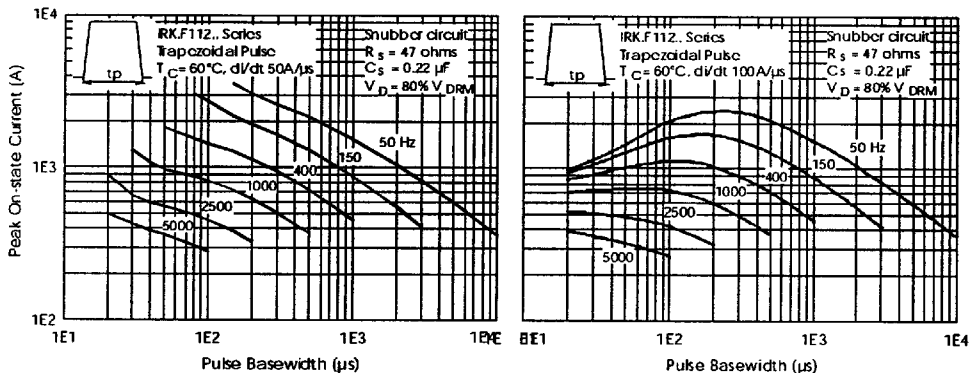


Fig. 13 - Frequency Characteristics

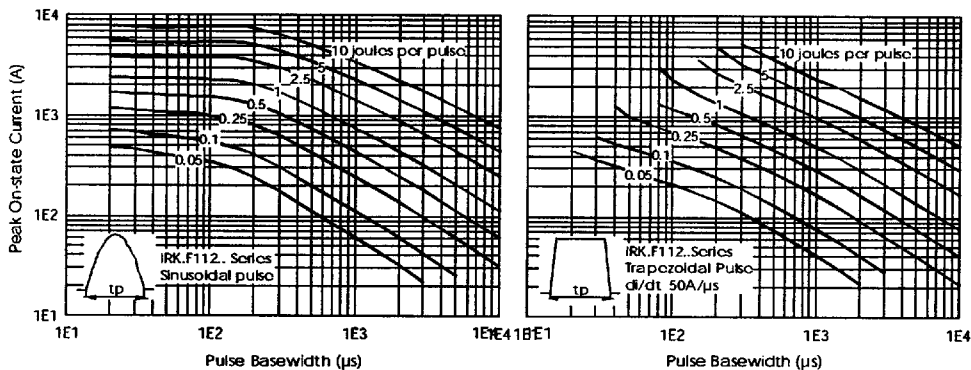


Fig. 14 - Maximum On-state Energy Power Loss Characteristics

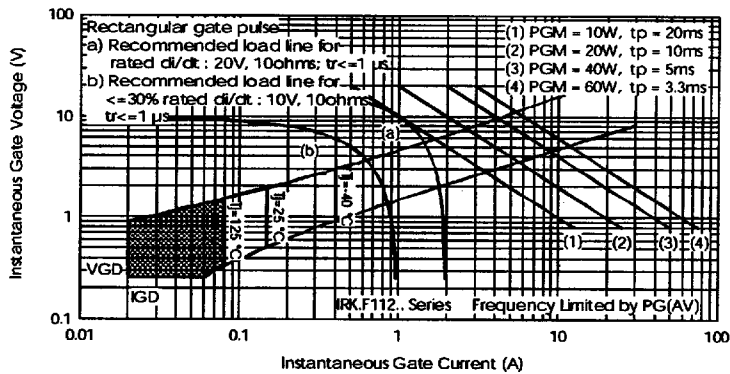


Fig. 15 - Gate Characteristics